Applicable	e standard										
Operating Temperature rar		nge			Stora	orage mperature range			-10 °C to +60°C (I	Note3)	
Rating	Operating Humidity range Applicable Connector Applicable contact		20% to 80% (Note2)  DF65-4S-1.7C		Stora	age	e ity range		40% to 70% (N	ote3)	
rtating						idity ran			AC 50 V		
					-		Current		24 AWG : 4.5	A	
			DF65-2428SCFA(**	<b>'</b> )		17			26-28 AWG : 3.5		
	Voltage		50 V AC/DC		C-UL	. Rating	_		AC 50 V		
Current		24 AWG : 4 A 26 AWG : 2.5 A			<u> </u>	1	Current		24 AWG : 4.5 A 26-28 AWG : 3 A		
			28 AWG : 2.5 A								
			Spe	cifica	tions	3					
Į†	tem		Test method					Req	uirements	QT	АТ
Construction											
General examination		Visually and by measuring instrument.			According to drawing.				X	Х	
Marking		Confirmed visually.								X	Χ
	haracterist		A.V. 4 (D.O. 400011.)			140 0				1 1/	
Contact Resistance millivolt level method		20mV MAX, 1mA(DC or 1000Hz).				10mΩ MAX.				X	_
Insulation resistance		100 V DC.			100 MΩ MIN.				X	_	
Voltage proof		500 V AC for 1 min.			No flashover or breakdown.				X	<del> </del>	
• •	cal charact					1				1 -	1
		50 times insertion and extraction.			①Contact resistance: 20mΩ MAX.				Х	T -	
•					②No damage, crack or looseness of parts.						
Vibration		Frequency 10 to 55 Hz, single amplitude					①No electrical discontinuity of 1μs. X				
Shock		0.75 mm, at 10 cycles for 3 direction. 490 m/s <sup>2</sup> duration of pulse 11 ms at 3 times each for			②No damage, crack or looseness of parts.					<del> </del>	
		3 both axial directions.								^	
Environm	ental charac					•				•	
Damp heat		Exposed at 40 ± 2°C , 90 to 95 %, 96 h.				①Contact resistance: 20mΩ MAX.				X	_
(Steady state)		(After leaving the room temperature for 1 - 2h.) Temperature -55°C→ +105°C				②Insulation resistance: 100 MΩ MIN. ③No damage, crack or looseness of parts.				1	
Rapid change of temperature			Time 30min → 30min				aarriago, (	JIGON	or looseriess of parts.	Х	_
temperature		Under 5									
			sferring time of the tank is 2								
Decistores t	o coldorina		iving the room temperature for	or 1 - 2h.)		No do	formation	of oo	and of evenesive	X	
heat	Resistance to soldering heat		1) Reflow soldering  «Reflow time»				No deformation of case of excessive looseness of the terminals.				-
		Number of reflow cycles : 2 cycles max.									
		Duration above 220°C, 60sec. max.									
		Peak temperature : 250°C 10 sec. max.  «Pre-heat time»									
		Pre-heat time P									
		Pre-heat temperature(max) : 180°C									
			Pre-heat time(min): 90 sec.								
			eat time(max) : 120 sec.								
		,	2) Manual soldering Soldering iron tempreture: 350±10°C,								
			ring time: 3s	,							
0 11 133			rength on contact.				.,			1	
			Soldered at solder temperature, 245°C for in immersion, duration, 5s.						ng of solder shall i% of the surface	X	_
		2-55 10				being immersed.					
	e the temperatur	e rising by o	current.							•	•
Note 2: No co Note 3: Apply	•	of long term	storage for unused products bef	ore mounte	ed on PC	B.					
		_	ture and humidity range are appl				ng transpor	tation	•		
Coun			Desig	signed			Checked				
2 Pomorko		DIS-	H-00004782		SN. M	IWA			SZ. ONO	-	0416
Remarks							Approv		HS. OKAWA	-	30806
							Check		SZ. ONO	-	30806
Unless otherwise specified, refer			r to IEC 60512.			Designed			TS. KUMAZAWA SN. MIWA		
	<u> </u>					Drawn			·		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test						Drawing No. ELC-351454- Int No. DF65-4P-1. 7V (78			ELC-351454-7	ช−U(	J
HS.			ilication sheet		raii	INU.					
	HIR	OSE E	LECTRIC CO., LTD.		Code	No.	CL666-6006-0-78				1/1